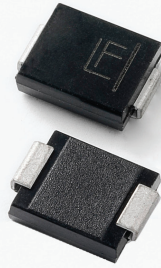


## 4.0SMDJ24A



### Uni-directional



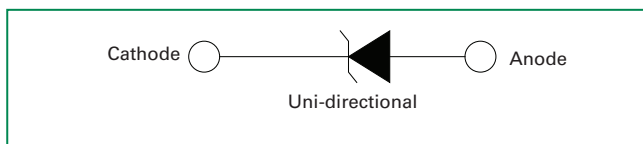
### Maximum Ratings and Thermal Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation at T <sub>A</sub> =25°C by 10/1000µs Waveform (Fig.2)(Note 1), (Note 2)	P <sub>PPM</sub>	4000	W
Power Dissipation on Infinite Heat Sink at T <sub>A</sub> =50°C	P <sub>M(AV)</sub>	6.5	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3)	I <sub>FSM</sub>	300	A
Maximum Instantaneous Forward Voltage at 100A for Unidirectional Only	V <sub>F</sub>	3.5	V
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C
Typical Thermal Resistance Junction to Lead	R <sub>WJL</sub>	15	°C/W
Typical Thermal Resistance Junction to Ambient	R <sub>WJA</sub>	75	°C/W

**Notes:**

1. Non-repetitive current pulse, per Fig. 4 and derated above T<sub>A</sub> = 25°C per Fig. 3.
2. Mounted on copper pad area of 0.31x0.31" (8.0 x 8.0mm) to each terminal.
3. Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional device only, duty cycle=4 per minute maximum.

### Functional Diagram



### Description

The 4.0SMDJ24A is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

### Features

- For surface mounted applications in order to optimize board space
- Low profile package
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- IEC-61000-4-2 ESD 15kV(Air), 8kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2 (IEC801-2)
- EFT protection of data lines in accordance with IEC 61000-4-4 (IEC801-4)
- Built-in strain relief
- V<sub>BR</sub> @T<sub>J</sub> = V<sub>BR</sub> @25°C x (1 + α T x (T<sub>J</sub> - 25)) (α T: Temperature Coefficient)
- Glass passivated chip junction
- 4000W peak pulse power capability at 10/1000µs waveform, repetition rate (duty cycles):0.01 %
- Fast response time: typically less than 1.0ps from 0V to BV min
- Excellent clamping capability
- Low incremental surge resistance
- High temperature soldering guaranteed: 260°C/40 seconds at terminals
- Meet MSL level1, per J-STD-020, LF maximum peak of 260°C
- Matte tin lead-free plated
- Halogen free and RoHS compliant
- 2nd level interconnect is Pb-free per IPC/JEDEC J-STD-609A.01

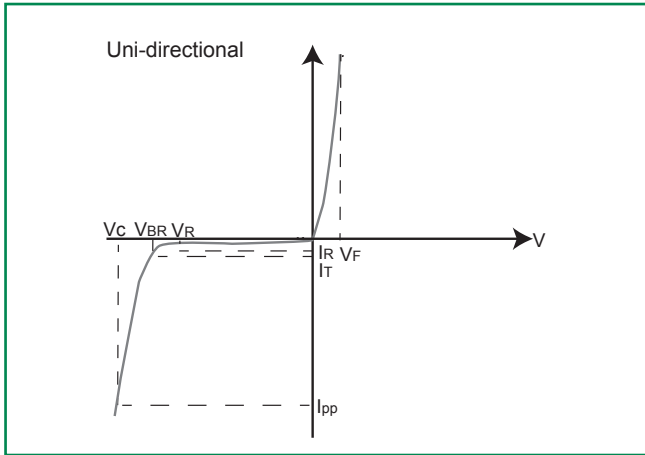
### Applications

TVS devices are ideal for the protection of I/O Interfaces, V<sub>CC</sub> bus and other vulnerable circuits used in Telecom, Computer, Industrial and Consumer electronic applications.

### Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Part Number	Marking	Reverse Stand off Voltage V <sub>R</sub> (Volts)	Breakdown Voltage V <sub>BR</sub> (Volts) @ I <sub>T</sub>		Test Current I <sub>T</sub> (mA)	Maximum Clamping Voltage V <sub>C</sub> @ I <sub>PP</sub> (10/1000µS) (V)	Maximum Clamping Voltage V <sub>C</sub> @ I <sub>PP</sub> (8/20µS) (V)	Maximum Peak Pulse Current I <sub>PP</sub> (10/1000µS) (A)	Maximum Peak Pulse Current I <sub>PP</sub> (8/20µS) (A)	Maximum Reverse Leakage I <sub>R</sub> @ V <sub>R</sub> (µA)
			MIN	MAX						
4.0SMDJ24A	4PEZ	24.0	26.70	29.50	1	38.9	51.0	103.0	650.0	2

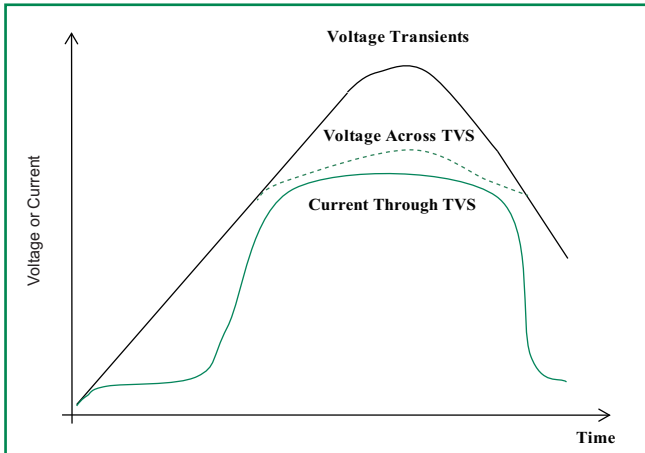
**I-V Curve Characteristics**



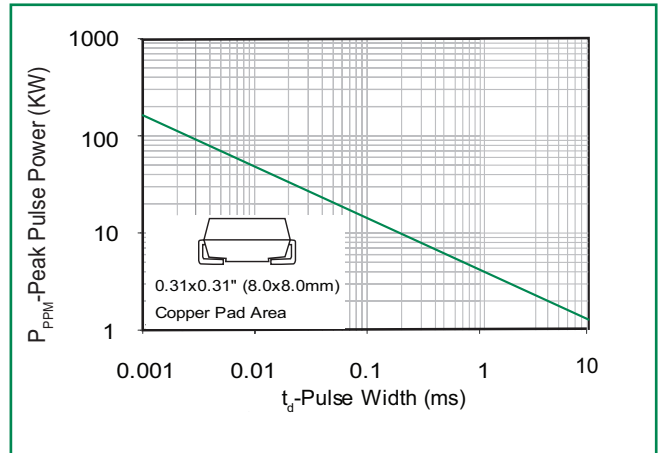
- P<sub>PPM</sub> Peak Pulse Power Dissipation** – Max power dissipation
- V<sub>R</sub> Stand-off Voltage** – Maximum voltage that can be applied to the TVS without operation
- V<sub>BR</sub> Breakdown Voltage** – Maximum voltage that flows through the TVS at a specified test current (I<sub>T</sub>)
- V<sub>C</sub> Clamping Voltage** – Peak voltage measured across the suppressor at a specified I<sub>ppm</sub> (peak impulse current)
- I<sub>R</sub> Reverse Leakage Current** – Current measured at V<sub>R</sub>
- V<sub>F</sub> Forward Voltage Drop for Uni-directional**

**Ratings and Characteristic Curves (T<sub>A</sub>=25°C unless otherwise noted)**

**Figure 1 - TVS Transients Clamping Waveform**



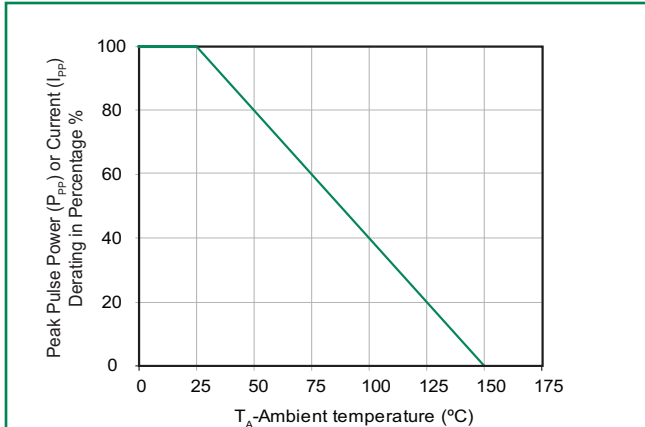
**Figure 2 - Peak Pulse Power Rating**



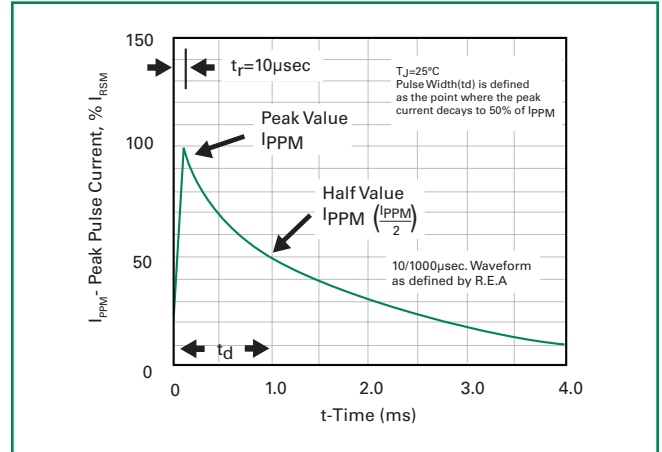
continues on next page.

**Ratings and Characteristic Curves** ( $T_A=25^\circ\text{C}$  unless otherwise noted) (Continued)

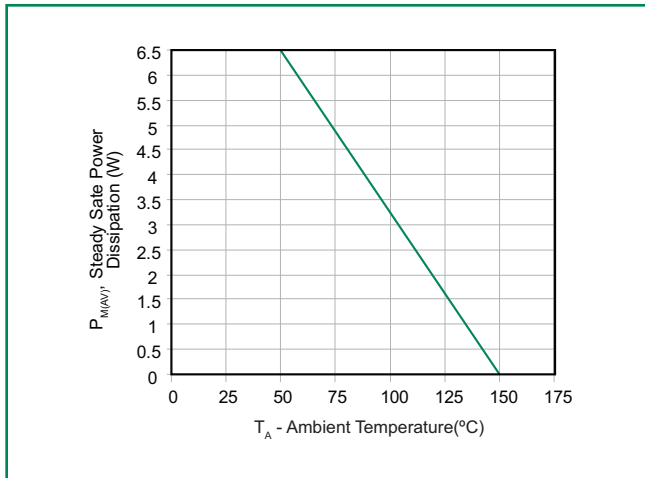
**Figure 3 - Peak Pulse Power or Current Derating Curve vs Initial Junction Temperature**



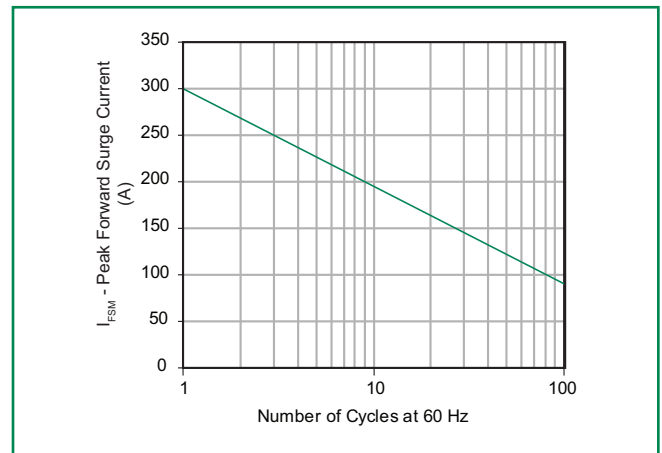
**Figure 4 - Pulse Waveform**



**Figure 5 - Steady State Power Derating Curve**

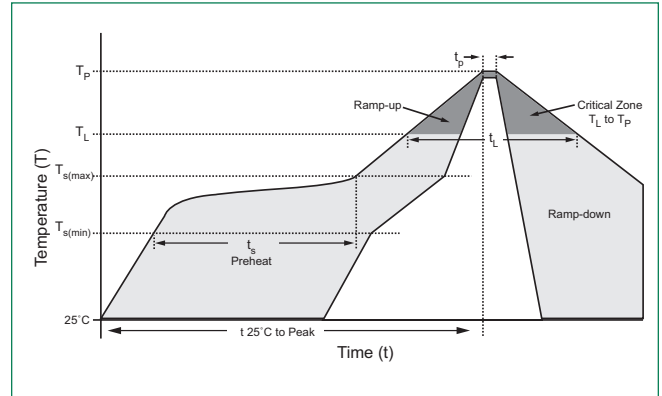


**Figure 7 - Maximum Non-Repetitive Peak Forward Surge Current Uni-Directional only**



**Soldering Parameters**

Reflow Condition		Lead-free assembly
Pre Heat	- Temperature Min ( $T_{s(min)}$ )	150°C
	- Temperature Max ( $T_{s(max)}$ )	200°C
	- Time (min to max) ( $t_s$ )	60 – 180 secs
Average ramp up rate (Liquidus Temp ( $T_L$ ) to peak)		3°C/second max
$T_{s(max)}$ to $T_L$ - Ramp-up Rate		3°C/second max
Reflow	- Temperature ( $T_L$ ) (Liquidus)	217°C
	- Time (min to max) ( $t_s$ )	60 – 150 seconds
Peak Temperature ( $T_p$ )		260 <sup>+0/-5</sup> °C
Time within 5°C of actual peak Temperature ( $t_p$ )		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature ( $T_p$ )		8 minutes Max.
Do not exceed		280°C



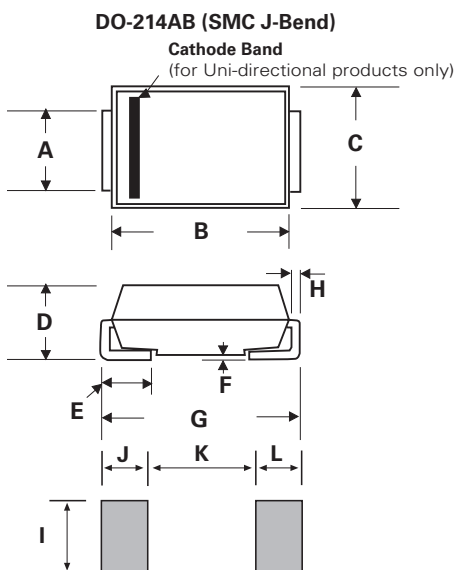
**Physical Specifications**

<b>Weight</b>	0.007 ounce, 0.21 grams
<b>Case</b>	JEDEC DO214AB. Molded plastic body over glass passivated junction
<b>Polarity</b>	Color band denotes positive end (cathode) except Bidirectional.
<b>Terminal</b>	Matte Tin-plated leads, Solderable per JESD22-B102

**Environmental Specifications**

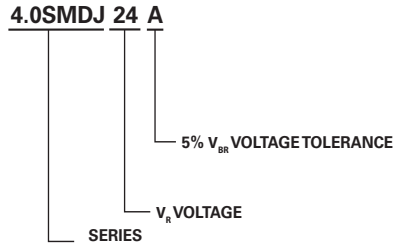
<b>High Temp. Storage</b>	JESD22-A103
<b>HTRB</b>	JESD22-A108
<b>Temperature Cycling</b>	JESD22-A104
<b>MSL</b>	JEDEC-J-STD-020, Level 1
<b>H3TRB</b>	JESD22-A101
<b>RSH</b>	JESD22-B106

**Dimensions**

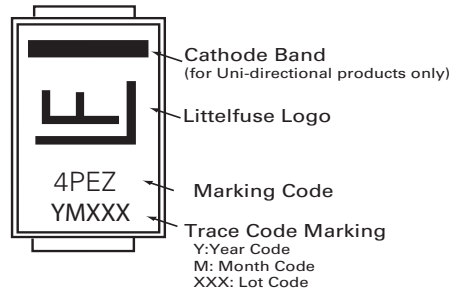


Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.114	0.126	2.900	3.200
B	0.260	0.280	6.600	7.110
C	0.220	0.245	5.590	6.220
D	0.079	0.103	2.060	2.620
E	0.030	0.060	0.760	1.520
F	-	0.008	-	0.203
G	0.305	0.320	7.750	8.130
H	0.006	0.012	0.152	0.305
I	0.129	-	3.300	-
J	0.094	-	2.400	-
K	-	0.165	-	4.200
L	0.094	-	2.400	-

**Part Numbering System**



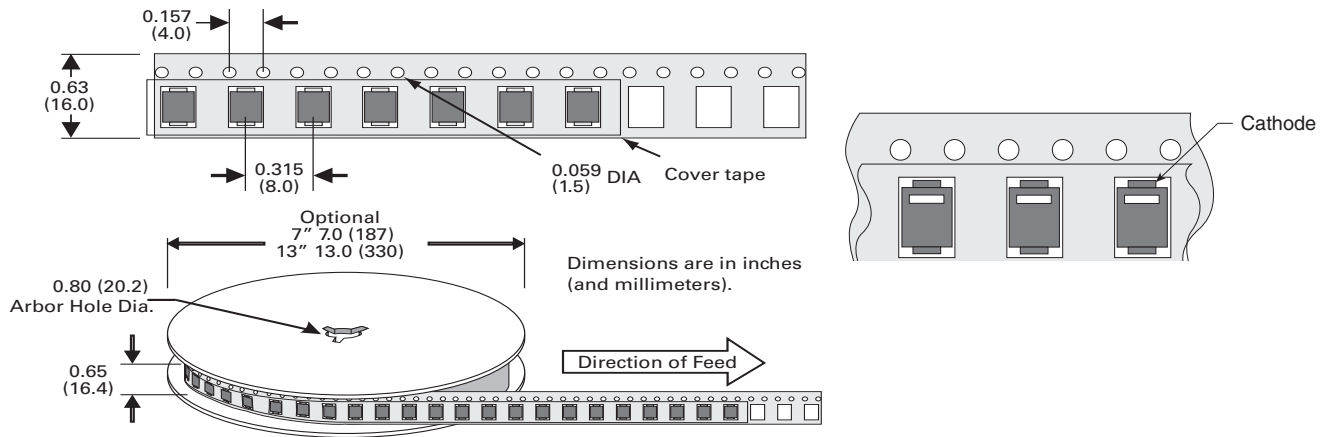
**Part Marking System**



**Packaging Options**

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
4.0SMDJ24A	DO-214AB	3000	Tape & Reel - 16mm tape/13" reel	EIA STD RS-481

**Tape and Reel Specification**



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- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
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- Комплексную поставку.
- Работу по проектам и поставку образцов.
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- Тестирование поставляемой продукции.
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- Входной контроль качества.
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- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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